

Vishay Siliconix

Dual N-Channel 25-V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	$R_{DS(on)}\left(\Omega\right)$	I _D (A) ^{a, e}	Q _g (Typ.)		
25	0.0195 at V _{GS} = 4.5 V	8	11		
	0.026 at $V_{GS} = 2.5 \text{ V}$	8	11		

S₁

 G_1

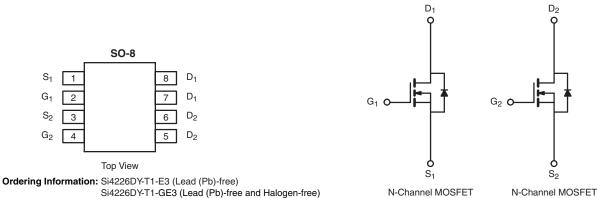
FEATURES

- Halogen-free According to IEC 61249-2-21 Available
- TrenchFET® Power MOSFET
- 100 % Rg and UIS Tested

HALOGEN **FREE**

APPLICATIONS

· Synchronous Buck Converter



Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	25	V	
Gate-Source Voltage		V_{GS}	± 12		
	T _C = 25 °C		8 ^e		
Continuous Drain Current (T _{.1} = 150 °C)	T _C = 70 °C	I _D	7.7		
Continuous Diam Current (1) = 150 C)	T _A = 25 °C	'D	7.5 ^{b, c}		
	T _A = 70 °C		6 ^{b, c}		
Pulsed Drain Current (10 µs Pulse Width)		I _{DM}	30	A	
Source-Drain Current Diode Current	T _C = 25 °C	l _a	2.6		
Source-Drain Current Diode Current	T _A = 25 °C	l _S	1.7 ^{b, c}		
Pulsed Source-Drain Current		I _{SM}	30		
Single Pulse Avalanche Current L = 0.1 mH		I _{AS}	10		
Single Pulse Avalanche Energy	L = 0.111111	E _{AS}	5	mJ	
	T _C = 25 °C		3.2		
Maximum Power Dissipation	T _C = 70 °C	P _D	2.1	W	
	T _A = 25 °C	I D	2 ^{b, c}	VV	
	T _A = 70 °C		1.28 ^{b, c}		
Operating Junction and Storage Temperature Range		T _J , T _{stq}	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient ^{b, d}	t ≤ 10 s	R _{thJA}	50	62.5	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	R_{thJF}	30	38	0/11		

Notes:

- a. Based on T_C = 25 °C.
- b. Surface Mounted on 1" x 1" FR4 board.
- c. t = 10 s.
- d. Maximum under Steady State conditions is 110 °C/W.
- e. Package limited.

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	25			V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	J 050 ·· A		26		mV/°C
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	- I _D = 250 μA		- 4		
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	0.6		2.0	V
Gate Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 12 \text{ V}$			100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 25 V, V _{GS} = 0 V			1	μΑ
		V _{DS} = 25 V, V _{GS} = 0 V, T _J = 55 °C			10	
On-State Drain Current ^b	I _{D(on)}	V _{DS} = 5 V, V _{GS} = 10 V	20			Α
	В	$V_{GS} = 4.5 \text{ V}, I_D = 7 \text{ A}$		0.0155	0.0195	Ω
Drain-Source On-State Resistance ^b	R _{DS(on)}	$V_{GS} = 2.5 \text{ V}, I_D = 5 \text{ A}$		0.020	0.026	
Forward Transconductance ^b	9 _{fs}	V _{DS} = 15 V, I _D = 7 A		40		S
Dynamic ^a						
Input Capacitance	C _{iss}			1255		pF
Output Capacitance	C _{oss}	N-Channel		185		
Reverse Transfer Capacitance	C _{rss}	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		90		
Tabal Cada Obanas		V _{DS} = 15 V, V _{GS} = 10 V, I _D = 8 A		24	36	nC
Total Gate Charge	Q_g			11	17	
Gate-Source Charge	Q_{gs}	N-Channel $V_{DS} = 15 \text{ V, } V_{GS} = 4.5 \text{ V, } I_{D} = 8 \text{ A}$		2		
Gate-Drain Charge	Q_{gd}	VDS = 10 V, VGS = 4.0 V, ID = 0 A		2.5		
Gate Resistance	R_g	f = 1 MHz	0.3	1.4	2.8	Ω
Turn-On Delay Time	t _{d(on)}			8	16	-
Rise Time	t _r	N-Channel $V_{DD} = 15 \text{ V, R}_{L} = 3 \Omega$		9	18	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 5 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$		24	40	
Fall Time	t _f	- Designation of the second		8	16	
Turn-On Delay Time	t _{d(on)}			14	25	ns
Rise Time	t _r	N-Channel $V_{DD} = 15 \text{ V, R}_{L} = 3 \Omega$		10	20	- - -
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 5 \text{ A}, V_{GEN} = 10 \text{ V}, R_q = 1 \Omega$		30	50	
Fall Time	t _f	- D - 7 GEN - 7 g		8	16	
Drain-Source Body Diode Characterist	cs					
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			2.6	
Pulse Diode Forward Current ^a	I _{SM}				30	A
Body Diode Voltage	V _{SD}	I _S = 2 A		0.73	1.2	V
Body Diode Reverse Recovery Time	t _{rr}			25	50	ns
Body Diode Reverse Recovery Charge	Q _{rr}	N-Channel		14	28	nC
Reverse Recovery Fall Time	t _a	I _F = 10 A, dl/dt = 100 A/μs, T _J = 25 °C		12		1
Reverse Recovery Rise Time	t _b	\dashv		13		ns

Notes:

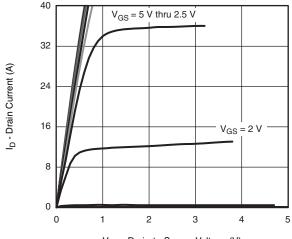
- a. Guaranteed by design, not subject to production testing.
- b. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

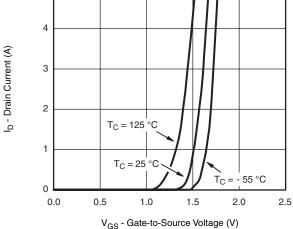


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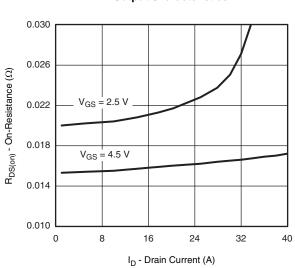
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



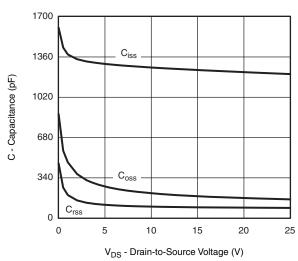
 V_{DS} - Drain-to-Source Voltage (V) **Output Characteristics**



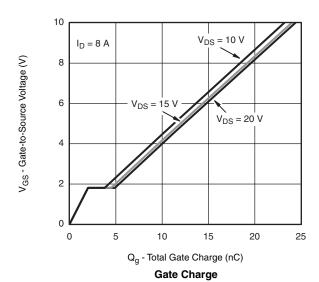
Transfer Characteristics

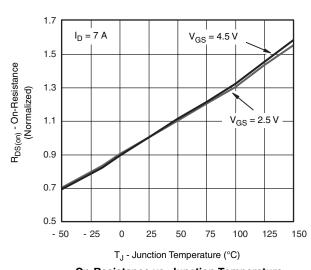


On-Resistance vs. Drain Current



Capacitance





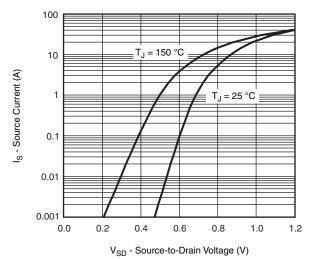
On-Resistance vs. Junction Temperature

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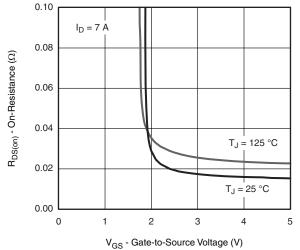
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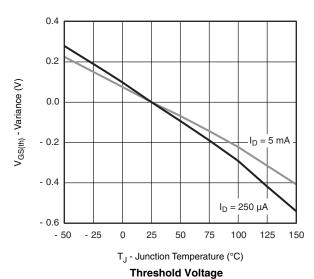
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

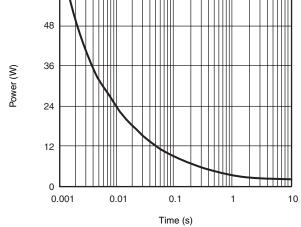


Source-Drain Diode Forward Voltage



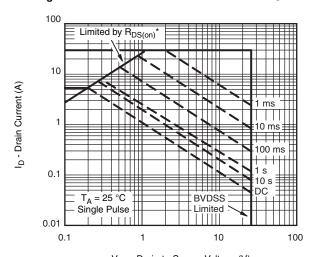
On-Resistance vs. Gate-to-Source Voltage





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Single Pulse Power, Junction-to-Ambient



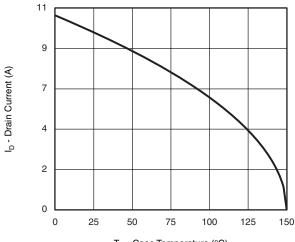
 $\rm V_{DS}$ - Drain-to-Source Voltage (V) * V $_{DS}$ > minimum V $_{GS}$ at which $\rm R_{DS(on)}$ is specified

Safe Operating Area



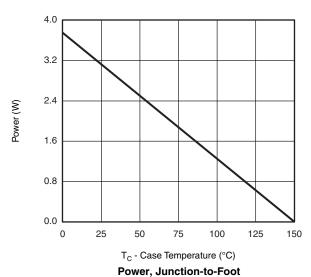
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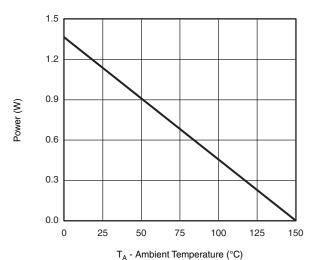
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



T_C - Case Temperature (°C)

Current Derating*





Power Derating, Junction-to-Ambient

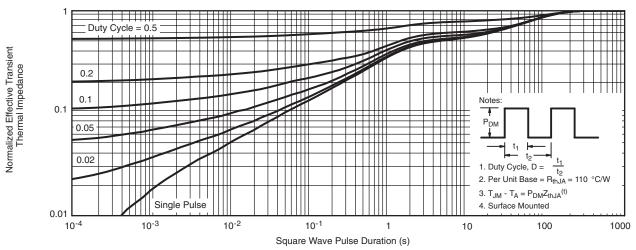
^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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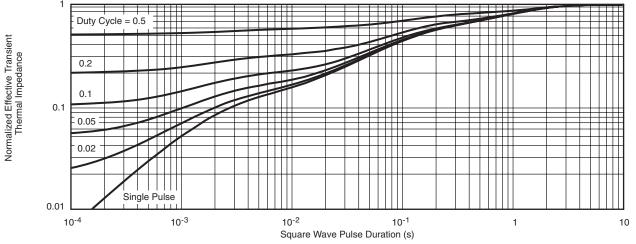
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

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